502369653 06/03/2013

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Ryozo SHIROISHI	05/20/2013
Kenichi TAKAO	05/20/2013

RECEIVING PARTY DATA

Name:	TOYO SEIKAN GROUP HOLDINGS, LTD.	
Street Address:	18-1, Higashi-Gotanda 2-chome, Shinagawa-ku	
City:	Tokyo	
State/Country:	JAPAN	
Postal Code:	141-8627	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13991294

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	P43954
NAME OF SUBMITTER:	Leslie J. Paperner
Signature:	/Leslie J. Paperner/
Date:	06/03/2013

Total Attachments: 1

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PATENT REEL: 030534 FRAME: 0679

Assignment

In consideration of One Dollar (\$1.00), and other good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned,

Ryozo SHIROISHI and Kenichi TAKAO, all citizens of Japan, residing respectively at Kanagawa, Japan and Kanagawa, Japan.

Hereby sell, assign and transfer to TOYO SEIKAN GROUP HOLDINGS, LTD. a corporation of Japan having a place of business at

18-1, Higashi-Gotanda 2-chome, Shinagawa-ku, Tokyo 141-8627 Japan its successors, assigns and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith May 20, 2013 , and is entitled Method of Polishing the Diamond-Surface

, and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: May 20, 2013	Ryozo SHIROICHI	(L.S.)
20, 20, 3	Kenichi TAKAO	(L.S.)
With		(L.S.)
Witness		(L.S.)
horio Takeuchi		(L.S.)
		(L.S.)

PATENT REEL: 030534 FRAME: 0680

RECORDED: 06/03/2013